

High- T_c SNS Weak Links Using Oxide Normal Metals

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Fabrication of high-quality, epitaxial SNS weak links with $\text{YBa}_2\text{Cu}_3\text{O}_{7-x}$ (YBCO) electrodes requires normal metals which are lattice-matched, chemically compatible, and possibly thermal-expansion-matched to YBCO. These requirements point to the use of oxide normal metals with compositions and structures similar to YBCO. This work examines device results for edge-geometry SNS weak links utilizing a variety of oxide normal metals, including a nonsuperconducting form of YBCO (N-YBCO), $\text{PrBa}_2\text{Cu}_3\text{O}_{7-x}$ (PBCO), and La and Co-doped YBCO. The devices are produced using an *in-situ* ion milling process to produce a tapered YBCO base-electrode edge with a MgO or SrTiO_3 milling mask. High-quality, RSJ-like electrical characteristics have been obtained with all of these barrier materials, and the devices generally show the expected exponential dependence of J_c on barrier thickness, with the exception of the La-doped-YBCO normal-metal devices. A comparison of the electrical properties of these devices, including $I_c R_n$, J_c , and the magnetic field response will be presented. Device reproducibility will also be discussed.

This talk will also examine recent progress in fabrication of epitaxial SNS weak links on silicon-on-sapphire (SOS) substrates. SOS substrates have acceptably low dielectric constants for many high-frequency applications, and offer the possibility of monolithic integration of silicon and superconducting circuitry. We have fabricated YBCO edge-geometry weak links with PBCO normal metal layers on r-plane SOS substrates using cubic zirconia (YSZ) buffer layers. These devices show good-quality RSJ-like I-V characteristics, but the electrical characteristics also indicate the presence of a second weak link in series with the edge-defined weak link, probably due to the nucleation of a grain boundary in the counterelectrode at the YSZ/base-YBCO interface. Recently, we have developed a new buffer layer combination which allows the growth of high quality YBCO/ SrTiO_3 bilayers above the YSZ film. SNS weak links fabricated using this approach are under investigation, and preliminary results on these devices will be reported.